

SEMITRANS® 10

IGBT R8 Modules

SKM1400GB17R8H1

Features*

- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
- UL recognized, file no. E63532

Typical Applications

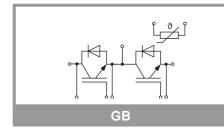
- Motor Drives
- UPS Systems
- Solar Inverters

Remarks

- Max. case temperature limited to $T_c = T_s = 125 \ ^\circ C$
- Recommended $T_{j,op}$ = -40...+150 $^{\circ}C$
- $I_{DC} \le 1000 \text{ A for } T_{Terminal} = 100 \text{ }^{\circ}\text{C}$

Absolute	Maximum Ratin	gs		
Symbol	Conditions		Values	Unit
IGBT				
V _{CES}	T _j = 25 °C		1700	V
Ic	T _j = 175 °C	T _c = 25 °C	2337	Α
		T _c = 100 °C	1527	Α
I _{Cnom}		· · · · · · · · · · · · · · · · · · ·	1400	Α
I _{CRM}			2800	A
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 1200 V$ $V_{GE} \le 15 V$ $V_{CES} \le 1700 V$	T _j = 150 °C	10	μs
Tj			-40 175	°C
Inverse o	diode			
V _{RRM}	Tj = 25 °C		1700	V
l _F	T _j = 175 °C	T _c = 25 °C	1874	Α
		T _c = 100 °C	1168	A
I _{FRM}			2800	A
I _{FSM}	tp = 10 ms, sin 180°, Tj = 25 °C		9024	A
Tj			-40 175	°C
Module				
I _{t(RMS)}			1000	Α
T _{stg}			-40 150	°C
Visol	AC sinus 50 Hz, t = 1 min		4000	V

Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
V _{CE(sat)}	$I_C = 1400 \text{ A}$ $V_{GE} = 15 \text{ V}$ chiplevel	T _j = 25 °C		1.63	1.95	V
		T _j = 150 °C		1.96	2.27	V
V	chiplevel	T _j = 25 °C		1.06	1.12	V
V_{CE0}		T _j = 150 °C		0.95	1.05	V
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		0.41	0.59	mΩ
		T _j = 150 °C		0.72	0.87	mΩ
$V_{\text{GE(th)}}$	V _{CE} = 10 V, I _C = 52	.8 mA	5	5.8	6.5	V
I _{CES}	V _{GE} = 0 V, V _{CE} = 17	700 V, T _j = 25 °C			6.0	mA
Cies		f = 1 MHz		139.2		nF
Coes	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		4.80		nF
Cres	02	f = 1 MHz		0.43		nF
Q_{G}	V _{GE} = - 15 V / + 15 V			8640		nC
R _{Gint}	T _j = 25 °C			1.7		Ω
t _{d(on)}	V _{CC} = 900 V	T _j = 150 °C		775		ns
tr	I _C = 1400 A V _{GE} = +15 V/-15 V	T _j = 150 °C		205		ns
Eon	$R_{Gon} = 2 \Omega$ $R_{Goff} = 2 \Omega$	$T_j = 150 {}^{\circ}C$		830		mJ
t _{d(off)}		T _j = 150 °C		865		ns
t _f	$di/dt_{on} = 6.3 \text{ kA/}\mu\text{s}$	T _j = 150 °C		180		ns
E _{off}	di/dt _{off} = 6.3 kA/μs dv/dt = 4500 V/μs L _s = 25 nH	T _j = 150 °C		520		mJ
R _{th(j-c)}	per IGBT				0.02	K/W
$R_{th(c-s)}$	per IGBT, (λ_{grease} = 0.81 W/(m*K))			0.010		K/W
R _{th(c-s)}	per IGBT, pre-applied phase change material			0.009		K/W





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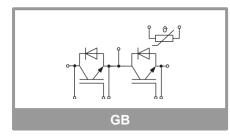
Typical Applications

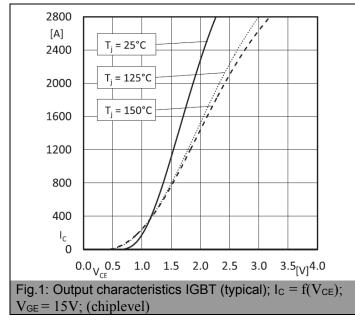
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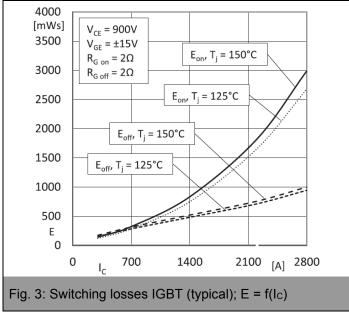
Remarks

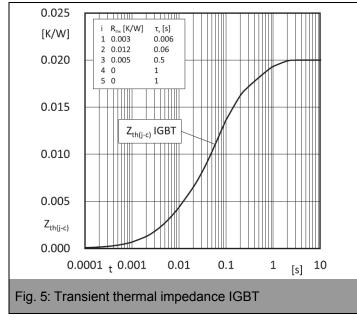
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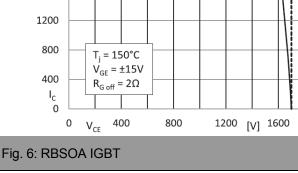
Characte	eristics					
Symbol	Conditions	min.	typ.	max.	Unit	
Inverse o	diode					
V _F = V _{EC}	$I_F = 1400 \text{ A}$ $V_{GE} = 0 \text{ V}$ chiplevel	T _j = 25 °C		1.84	2.19	V
		T _j = 150 °C		1.89	2.25	V
V _{F0}	chiplevel	T _i = 25 °C		1.32	1.56	V
		T _j = 150 °C		1.08	1.22	V
ſ _F	chiplevel	T _j = 25 °C		0.37	0.45	mΩ
		T _j = 150 °C		0.58	0.74	mΩ
I _{RRM}	I _F = 1400 A di/dt _{off} = 6.4 kA/μs V _{GF} = -15 V	T _j = 150 °C		925		Α
Q _{rr}		T _j = 150 °C		420		μC
Err	$V_{CC} = 900 V$	T _i = 150 °C		208		mJ
R _{th(j-c)}	per diode				0.032	K/W
R _{th(c-s)}	per diode, ($\lambda_{grease} = 0.81 \text{ W/(m*K)}$)			0.013		K/W
R _{th(c-s)}	per diode, pre-applied phase change material			0.011		K/W
Module	·					
L _{CE}				10		nH
R _{cc'+EE'}	measured per switch, T_C = 25 °C			0.20		mΩ
R _{th(c-s)1}	calculated without thermal coupling $(\lambda_{grease}=0.81 \text{ W}/(m^*K))$			0.0028		K/W
R _{th(c-s)2}	including thermal coupling, T _s underneath module $(\lambda_{grease}=0.81 \text{ W/(m*K)})$			0.005		K/W
R _{th(c-s)2}	including thermal coupling, T _s underneath module, pre-applied phase change material			0.004		K/W
Ms	to heat sink M5		4		6	Nm
M _t	to terminal M8 to terminal M4		8		10	Nm
			1.8		2.1	Nm
W					1250	g
	ture Sensor	<u></u>				1 -
R ₁₀₀	T _c =100°C (R ₂₅ =5 kΩ)			493 ± 5%		Ω
B _{100/125}	$R_{(T)}=R_{100}exp[B_{100/125}(1/T-1/T_{100})]; T[K];$			3550 ±2%		К

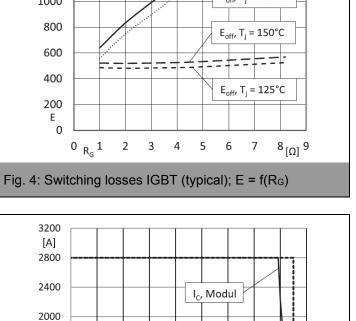




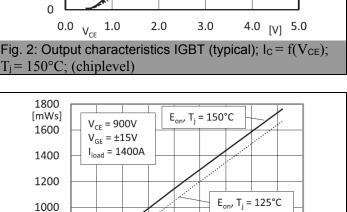


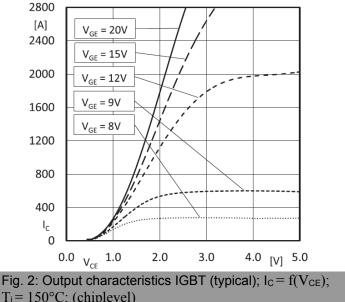






I_c, Chip

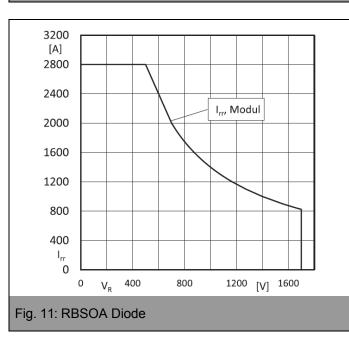


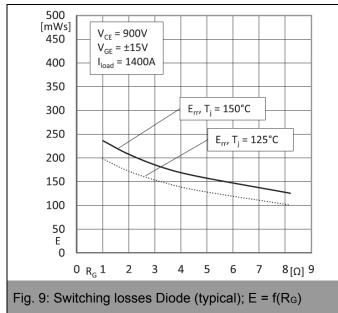


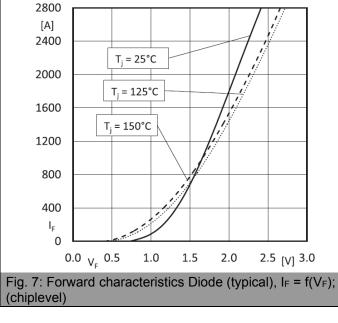
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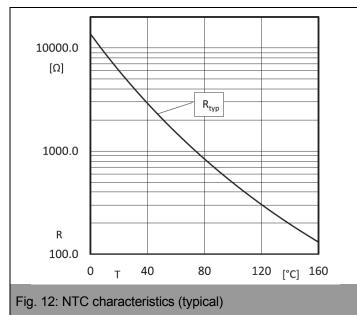
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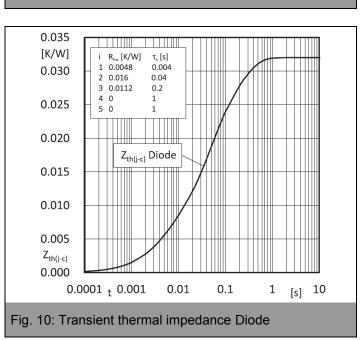
Rev. 1.0 – 20.06.2023

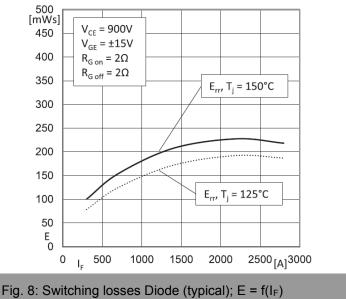






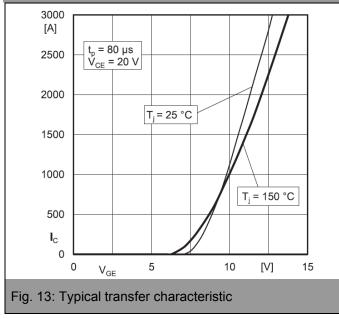


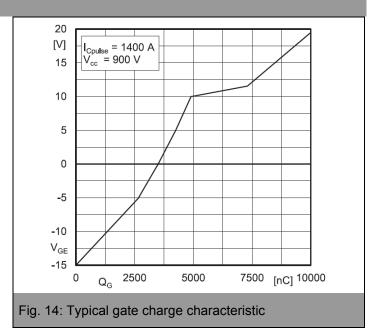


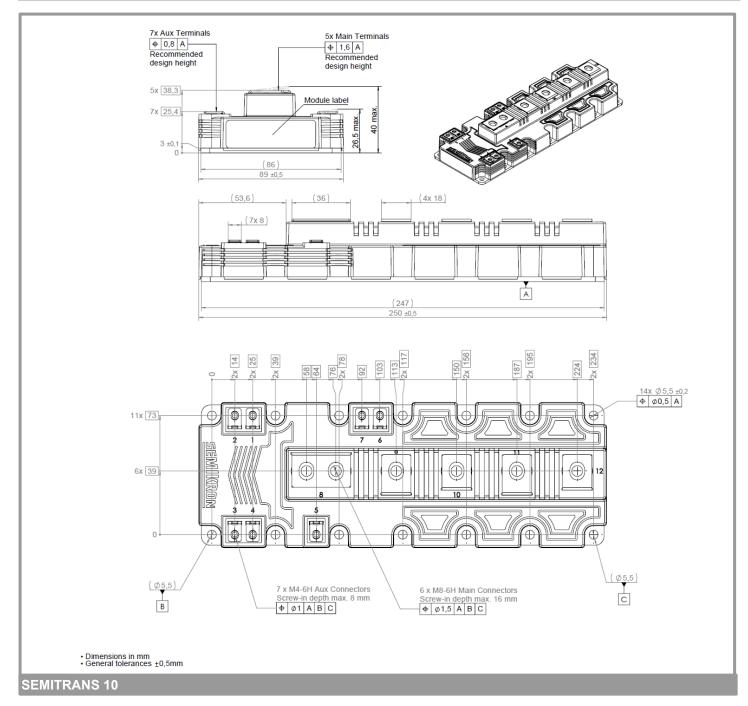


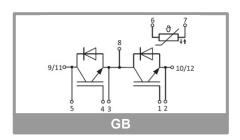
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This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

***IMPORTANT INFORMATION AND WARNINGS**

The specifications of SEMIKRON products may not be considered as any guarantee or assurance of product characteristics

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